

Fast Switching Diodes

Features

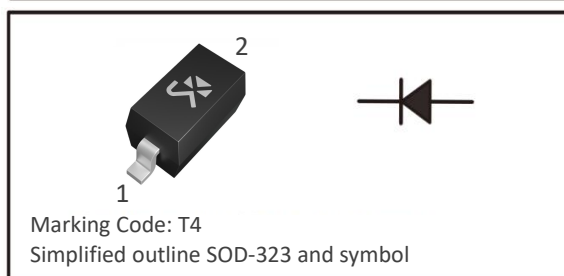
- For surface mounted applications
- Glass passivated chip junction
- Fast reverse recovery time
- Ideal for automated placement
- Lead free in comply with EU RoHS 2011/65/EU directives

Mechanical Data

- Case: SOD-323
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 5.48mg/0.00019oz

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Absolute Maximum Ratings @ $T_a = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	1N4148W	Unit
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	100	V
Maximum RMS Voltage	V_{RMS}	75	V
Average Rectified Forward Current	$I_{F(AV)}$	150	mA
Non-Repetitive Peak Forward Surge Current	at 1s	0.5	A
	at 1ms	1	A
	at 1us	4	A
Total Power Dissipation	P_{tot}	400	mW
Typical Thermal Resistance ⁽¹⁾	$R_{\theta JA}$	340	$^\circ\text{C/W}$
	$R_{\theta JC}$	120	$^\circ\text{C/W}$
Operating and Storage Temperature Range	T_J, T_{STG}	-55~+150	$^\circ\text{C}$

(1) P.C.B. mounted with 5*5mm copper pad areas

Electrical Characteristics @ $T_a = 25^\circ\text{C}$, unless specified otherwise

Parameter	Symbol	Test Condition	1N4148W	Unit
Reverse Breakdown Voltage	$V_{(BR)R}$	$I_R = 1\mu\text{A}$	100	V
Maximum Forward Voltage	V_F	$I_F = 1\text{mA}$	0.715	V
		$I_F = 10\text{mA}$	0.855	V
		$I_F = 50\text{mA}$	1.00	V
		$I_F = 150\text{mA}$	1.25	V
Peak Reverse Current	I_R	$V_R = 20\text{V}, T_J = 25^\circ\text{C}$	0.025	μA
		$V_R = 75\text{V}, T_J = 25^\circ\text{C}$	1	μA
		$V_R = 25\text{V}, T_J = 150^\circ\text{C}$	30	μA
		$V_R = 75\text{V}, T_J = 150^\circ\text{C}$	50	μA
Typical Junction Capacitance	C_J	$V_R = 0\text{V}, f = 1\text{MHz}$	2	pF
Maximum Reverse Recovery Time	t_{rr}	$I_F = I_R = 10\text{mA}, I_{tr} = 0.1 * I_R, R_L = 100\Omega$	4	ns

Typical Characteristics

Fig.1 Power Derating Curve

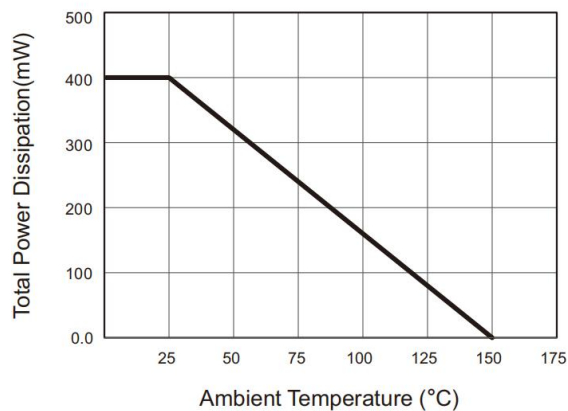


Fig.2 Typical Reverse Characteristics

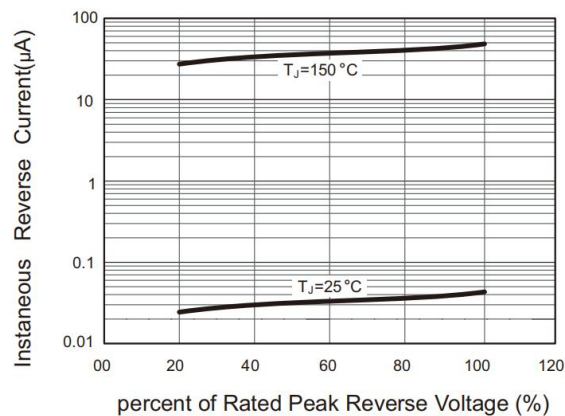


Fig.3 Typical Instantaneous Forward Characteristics

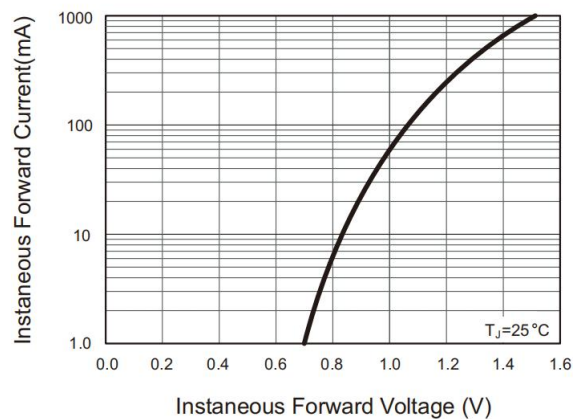
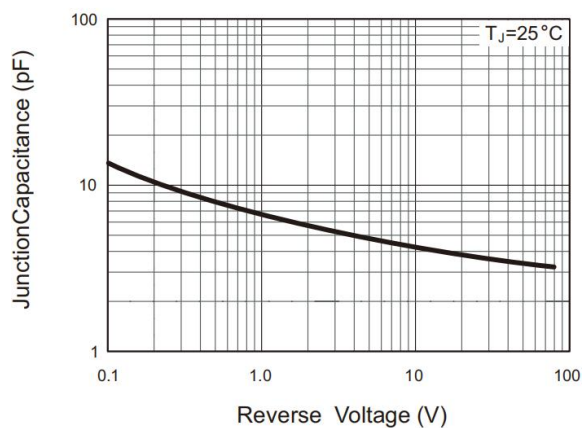


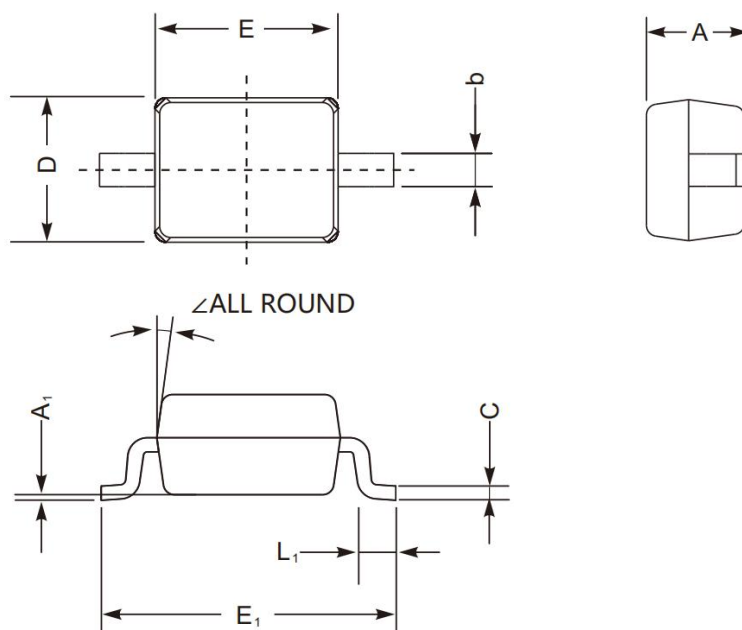
Fig.4 Typical Junction Capacitance



Package Information

SOD-123

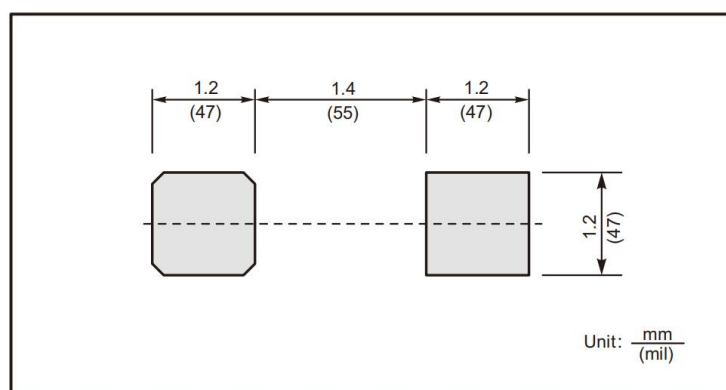
Dimensions in mm



SOD-323 mechanical data

UNIT		A	C	D	E	E ₁	b	L ₁	A ₁	∠
mm	max	1.1	0.15	1.4	1.8	2.75	0.4	0.45	0.2	9°
	min	0.8	0.08	1.2	1.4	2.55	0.25	0.2	—	
mil	max	43	5.9	55	70	108	16	16	8	
	min	32	3.1	47	63	100	9.8	7.9	—	

The recommended mounting pad size



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